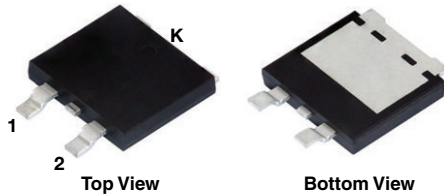
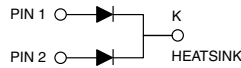


## Dual Trench MOS Barrier Schottky Rectifier

 Ultra Low  $V_F = 0.39\text{ V}$  at  $I_F = 5\text{ A}$ 
**TMBS<sup>®</sup> eSMP<sup>®</sup> Series  
TO-263AC (SMPD)**

**V30D60C**

**FEATURES**

- Trench MOS Schottky technology
- Very low profile - typical height of 1.7 mm
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- AEC-Q101 qualified
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS  
COMPLIANT  
HALOGEN  
FREE**
**TYPICAL APPLICATIONS**

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection.

**PRIMARY CHARACTERISTICS**

$I_{F(AV)}$	2 x 15 A
$V_{RRM}$	60 V
$I_{FSM}$	170 A
$V_F$ at $I_F = 15\text{ A}$	0.57 V
$T_J$ max.	150 °C
Package	TO-263AC (SMPD)
Diode variations	Common cathode

**MECHANICAL DATA**
**Case:** TO-263AC (SMPD)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** As marked

**MAXIMUM RATINGS** ( $T_A = 25\text{ °C}$  unless otherwise noted)

PARAMETER	SYMBOL	V30D60C	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	60	V
Maximum average forward rectified current (fig. 1)	$I_{F(AV)}$	per device	30
		per diode	15
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	170	A
Voltage rate of change (rated $V_R$ )	dV/dt	10 000	V/ $\mu$ s
Operating junction and storage temperature range	$T_J, T_{STG}$	- 40 to + 150	°C

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage per diode	$I_F = 5\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.47	-	V
	$I_F = 7.5\text{ A}$			0.51	-	
	$I_F = 15\text{ A}$			0.60	0.70	
	$I_F = 5\text{ A}$	$T_A = 125\text{ }^\circ\text{C}$		0.38	-	
	$I_F = 7.5\text{ A}$			0.44	-	
	$I_F = 15\text{ A}$			0.57	0.65	
Reverse current per diode	$V_R = 60\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	-	1200	$\mu\text{A}$
		$T_A = 125\text{ }^\circ\text{C}$		17	60	mA

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
 (2) Pulse test: Pulse width  $\leq 5\text{ ms}$

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V30D60C	UNIT	
Typical thermal resistance	per diode	$R_{\theta JC}$	2.5	$^\circ\text{C/W}$
			per device	
	per device	$R_{\theta JA}^{(1)(2)}$	48	

**Notes**

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$   
 (2) Free air, without heatsink

<b>ORDERING INFORMATION</b> (Example)					
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
TO-263AC (SMPD)	V30D60C-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel
TO-263AC (SMPD)	V30D60CHM3/I <sup>(1)</sup>	0.55	I	2000/reel	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified

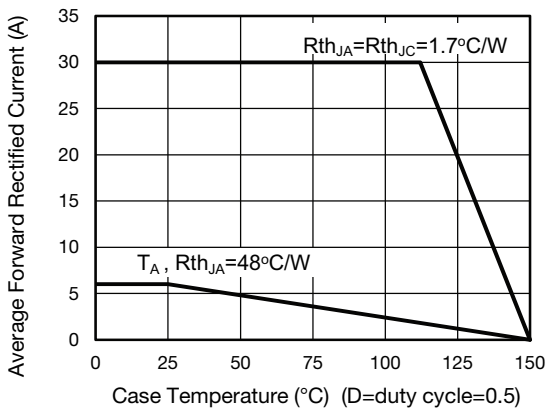
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)


Fig. 1 - Forward Current Derating Curve

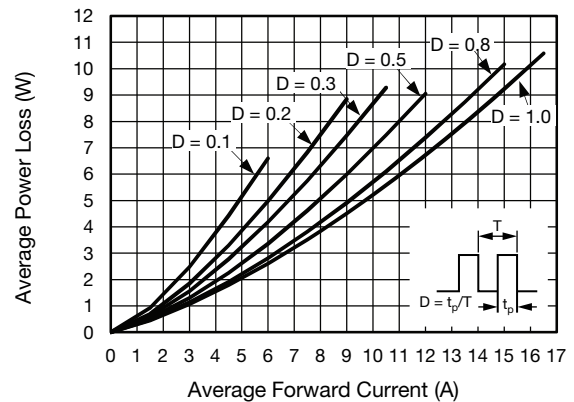


Fig. 2 - Forward Power Loss Characteristics Per Diode

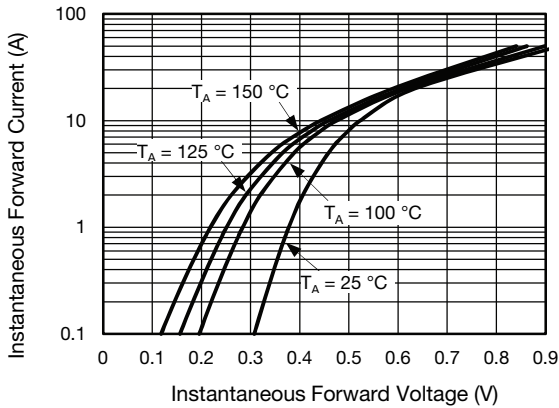


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

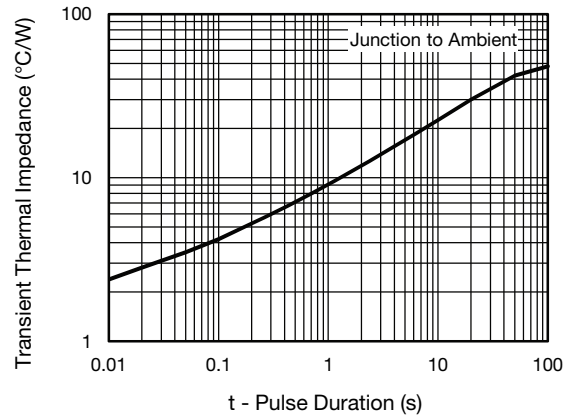


Fig. 6 - Typical Transient Thermal Impedance Per Diode

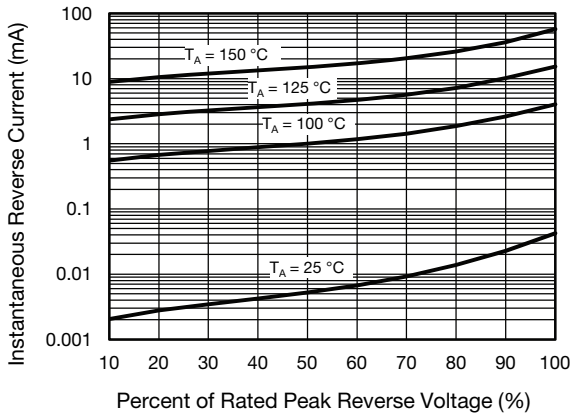


Fig. 4 - Typical Reverse Characteristics Per Diode

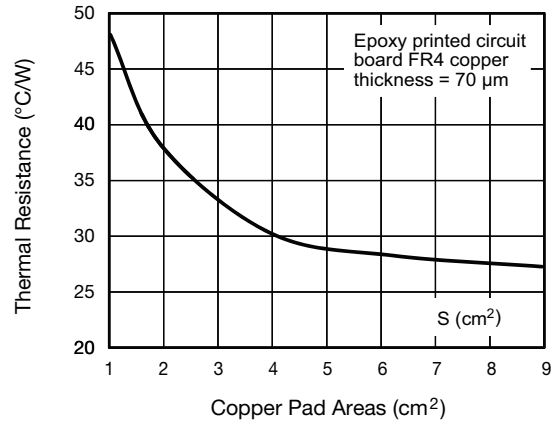


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

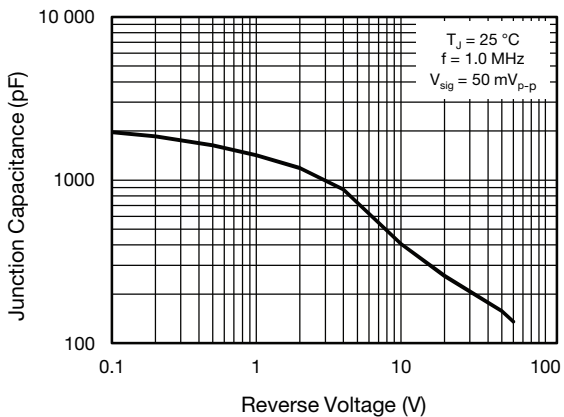
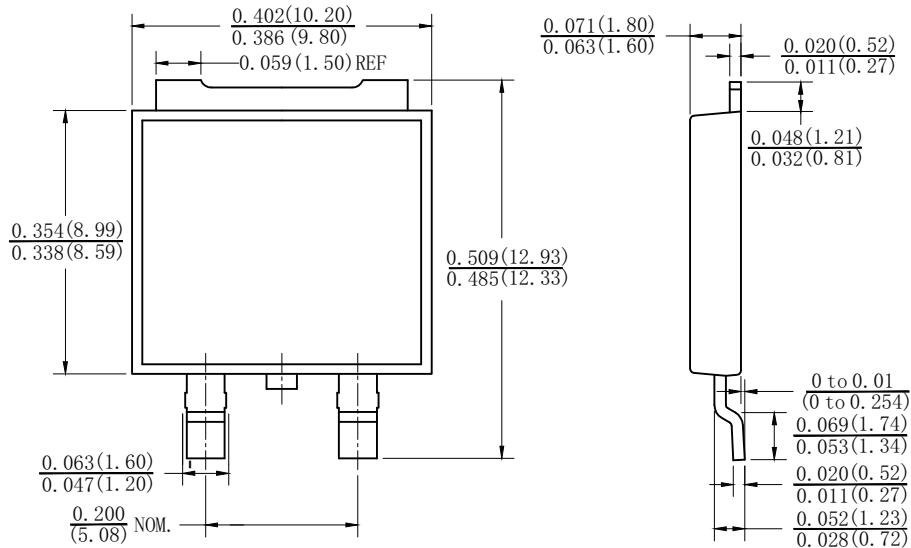


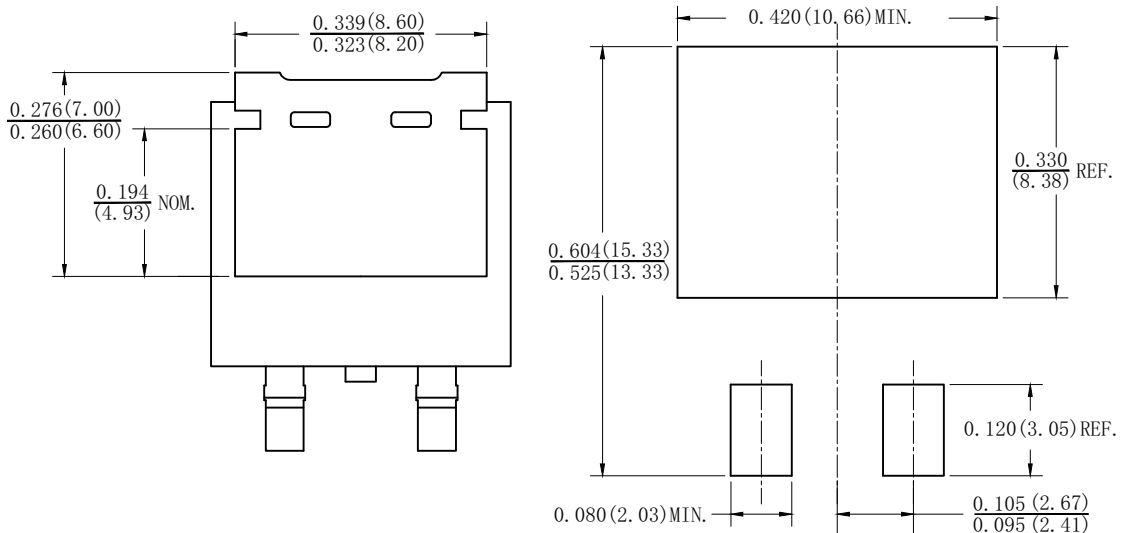
Fig. 5 - Typical Junction Capacitance Per Diode

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**TO-263AC (SMPD)**



**Mounting Pad Layout**





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**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

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